



60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
	23mΩ @ V _{GS} = 10V	44A
60V	28mΩ @ V _{GS} = 4.5V	40A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

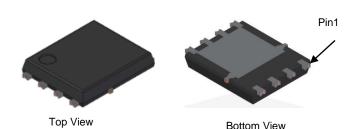
- Backlighting
- Power Management Functions
- DC-DC Converters

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switch (UIS) Test in Production
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMNH6021SPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

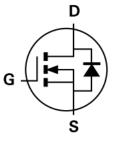
https://www.diodes.com/quality/product-definitions/

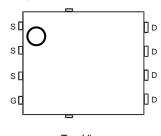
PowerDI5060-8 (SWP) (Type UX)



Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.097 grams (Approximate)





Internal Schematic

Top View Pin Configuration

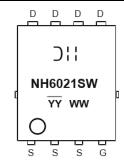
Ordering Information (Note 4)

Part Number	Case	Packaging
DMNH6021SPSWQ-13	PowerDI5060-8 (SWP) (Type UX)	2,500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



☐ → H = Manufacturer's Marking

MH6021SW = Product Type Marking Code

YYWW = Date Code Marking

YY = Year (ex: 20 = 2020)

WW = Week (01 to 53)



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage	VDSS	60	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current, V _{GS} = 10V (Note 7)	T _C = +25°C T _C = +100°C	lo	44 31	А	
Maximum Continuous Body Diode Forward Current (Note 7)	ls	44	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	IDM	176	Α		
Pulsed Source Current (10µs Pulse, Duty Cycle = 1%)		lsм	176	Α	
Avalanche Current, L = 0.1mH	las	35.7	Α		
Avalanche Energy, L = 0.1mH	E _{AS}	64	mJ		

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	1.6	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _θ JA	96	°C/W
Total Power Dissipation (Note 6)		PD	3.0	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	50	°C/W
Total Power Dissipation (Note 7)		P _D	100	W
Thermal Resistance, Junction to Case (Note 7)	Steady State	R _θ JC	1.5	°C/W
Operating and Storage Temperature Range	•	TJ, TSTG	-55 to +175	°C

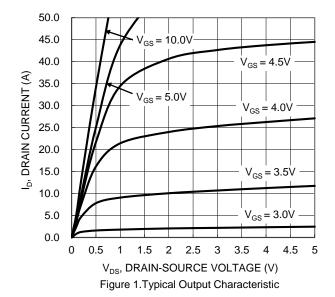
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

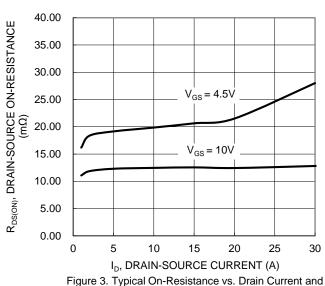
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BVDSS	60	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	1	_	1	μΑ	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	Vgs(TH)	1	_	3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	_	_	12	23	mΩ	Vgs = 10V, ID = 12A	
Static Drain-Source On-Resistance	R _{DS(ON)}	-	20	28	11122	V _G S = 4.5V, I _D = 12A	
Diode Forward Voltage	VsD	_	0.75	1.2	V	V _G S = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	-	1,132	_		V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	l	157	_	pF		
Reverse Transfer Capacitance	Crss	1	75	_			
Gate Resistance	Rg	_	2.5	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	9.7	_		V _{DS} = 30V, I _D = 20A	
Total Gate Charge (Vgs = 10V)	Qg	_	20.1	_	nC		
Gate-Source Charge	Q _{gs}	_	4.3	_	IIC		
Gate-Drain Charge	Q_{gd}	_	5.5	_			
Turn-On Delay Time	td(ON)	_	4.4	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_{D} = 20A, R_{G} = 4.7\Omega$	
Turn-On Rise Time	t _R	_	6.0	_	20		
Turn-Off Delay Time	t _D (OFF)	_	14.2	_	ns		
Turn-Off Fall Time	tF	_	5.4	_			
Body Diode Reverse Recovery Time	trr	_	21.2	_	ns	I= 20 A di/dt 100 A / u.c	
Body Diode Reverse Recovery Charge	Q _{RR}	_	15.2	_	nC	$I_F = 20A$, $di/dt = 100A/\mu s$	

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.









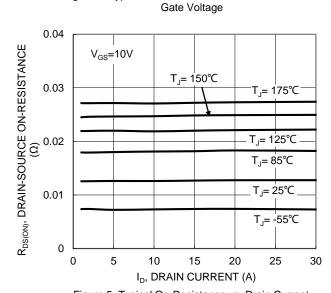
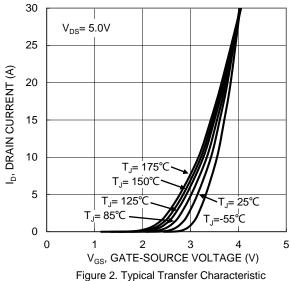


Figure 5. Typical On-Resistance vs. Drain Current and Temperature



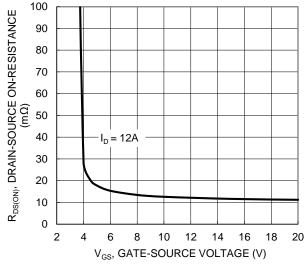


Figure 4. Typical Transfer Characteristic

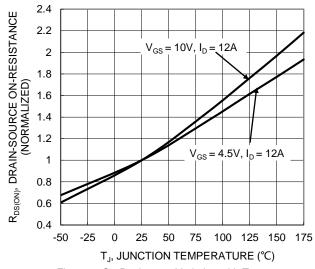


Figure 6. On-Resistance Variation with Temperature





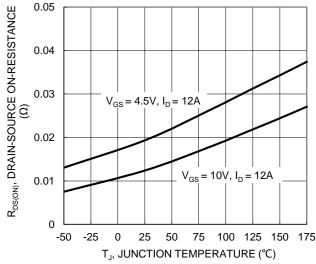


Figure 7. On-Resistance Variation with Temperature

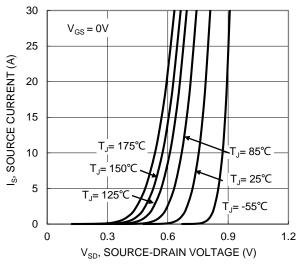


Figure 9. Diode Forward Voltage vs. Current

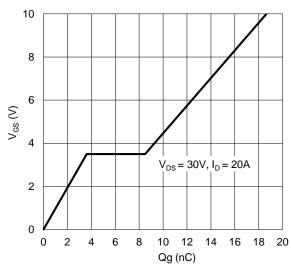


Figure 11. Gate Charge

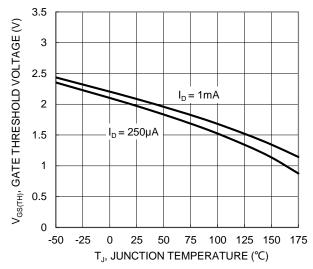
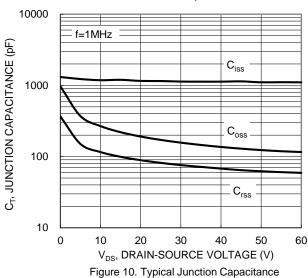


Figure 8. Gate Threshold Variation vs. JunctionTemperature



1000 R_{DS(ON)} LIMITED 100 ID, DRAIN CURRENT (A) 10 $T_{J(MAX)}$ =175°C P_W=100ms T_C=25℃ DC Single Pulse DUT on infinite heatsink V_{GS}=10V 0.01 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



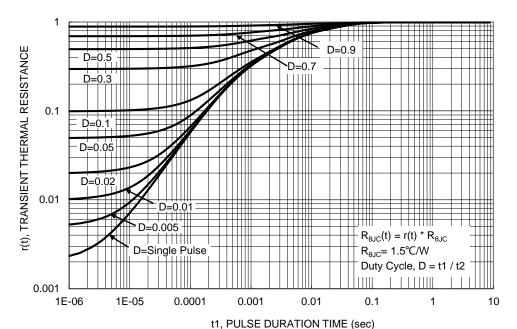


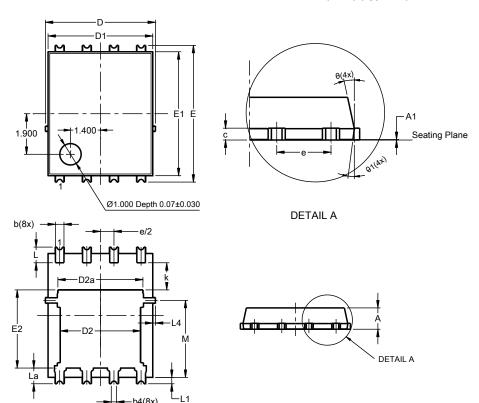
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type UX)

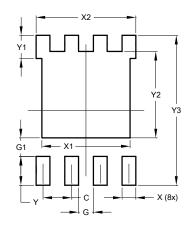


Pov	PowerDI5060-8 (SWP) (Type UX)				
Dim	Min	Тур			
Α	0.90	1.10	1.00		
A1	0	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	().25REF			
С	0.230	0.330	0.277		
D	5	.15 BS0			
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78	4.18	3.98		
E	6	.40 BS0			
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1.27BSC				
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
L1a	0.050REF				
L4	0.025	0.225	0.125		
М	3.205	4.005	3.605 11°		
θ		10° 12°			
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type UX)



Dimensions	Value		
Dillielisions	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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